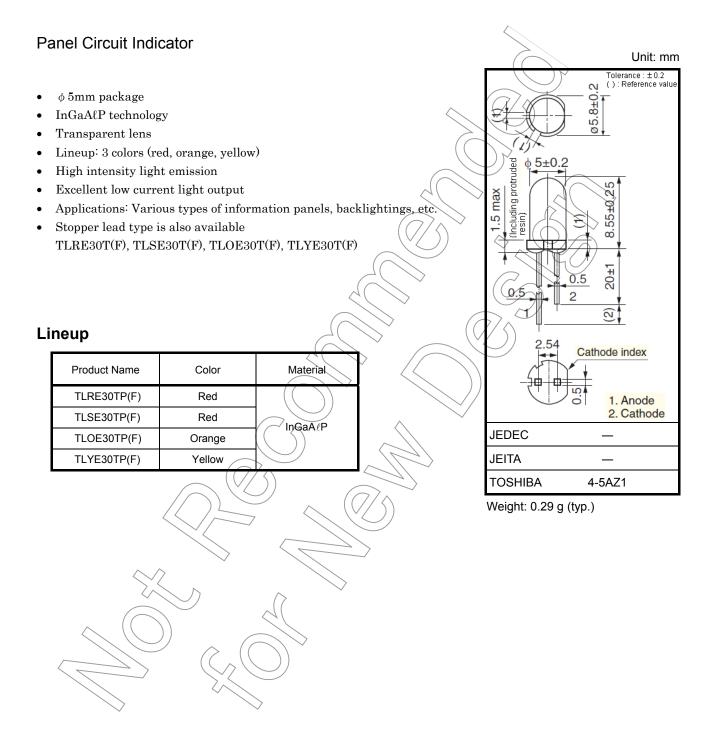
TOSHIBA InGaAlP LED

TLRE30TP(F),TLSE30TP(F),TLOE30TP(F),TLYE30TP(F)



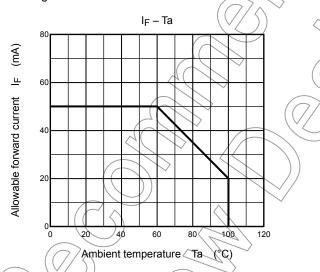
Absolute Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I _F (mA) (Note 1)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLRE30TP(F)					
TLSE30TP(F)	50	4	120	–40∕to√100	-40 to 120
TLOE30TP(F)			120	-4010 100	-40 to 120
TLYE30TP(F)					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



Electrical and Optical Characteristics (Ta = 25°C)

Product Name	Typ. Emission Wavelength			Luminous Intensity		Forward Voltage V _F			Reverse Current I _R			
	$\left\langle \lambda_{d} \right\rangle$	λΡ	Δλ	lF	Min	Тур.	lF	Тур.	Max	lF	Max	V _R
TLRE30TP(F)	630	644	20 (20	153	600	20	1.9	2.4	20	50	4
TLSE30TP(F)	613	623	20	20	272	1000	20	1.9	2.4	20	50	4
TLOE30TR(F)	605	612	20	20	476	1400	20	2.0	2.4	20	50	4
TLYE30TP(F)	587	590	7	20	476	1300	20	2.0	2.4	20	50	4
Unit		nmî		mA	m	cd	mA	\	/	mA	μА	V

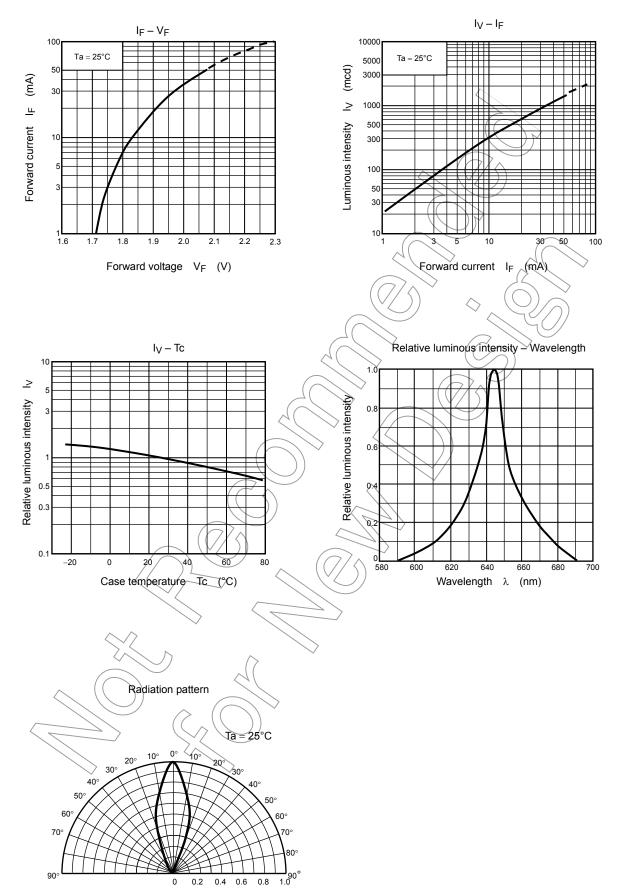
Precautions

Please be careful of the following:

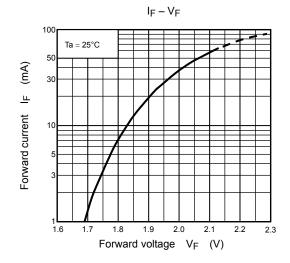
- Soldering temperature: 260°C max, soldering time: 3 s max (Soldering portion of lead: up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light.

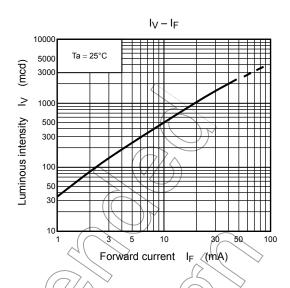
 If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

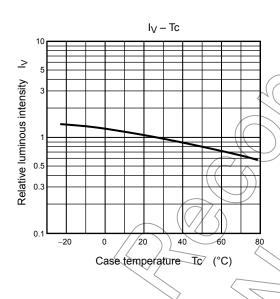
TLRE30TP(F)

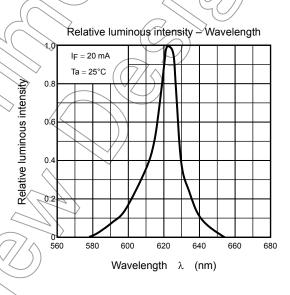


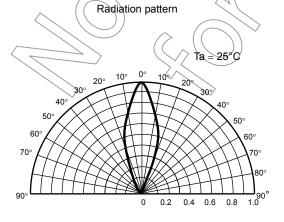
TLSE30TP(F)





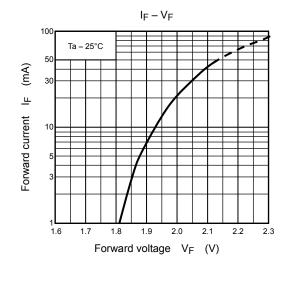


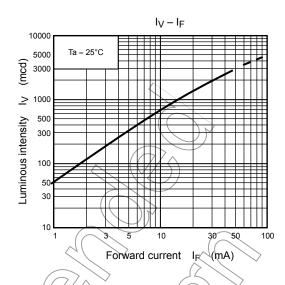


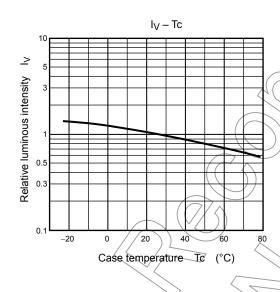


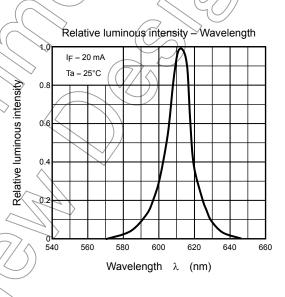
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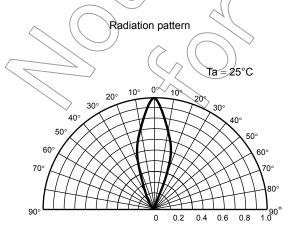
TLOE30TP(F)



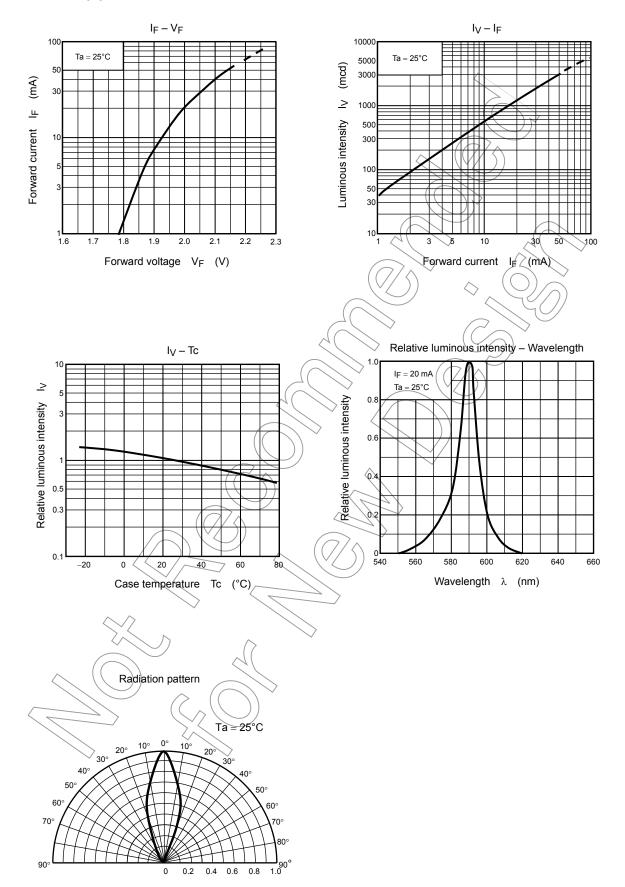








TLYE30TP(F)



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